

STGY40NC60VD

N-channel 600V - 50A - Max247 Very fast PowerMESH™ IGBT

Features

Туре	V _{CES}	V _{CE(sat)} (max)@25°C	I _C @100°C
STGY40NC60VD	600V	< 2.5V	50A

- High current capability
- High frequency operation up to 50kHz
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode



Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding performances. The suffix "V" identifies a family optimized for very high frequency applications.

Applications

- High frequency inverters, UPS
- SMPS and PFC in both hard switch and resonant topologies
- Motor drivers

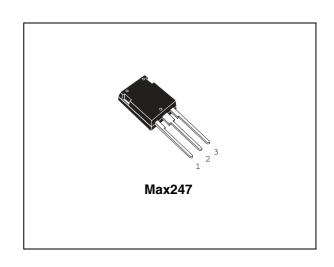


Figure 1. Internal schematic diagram

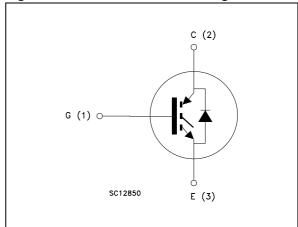


Table 1. Device summary

Order code	Marking	Package	Packaging	
STGY40NC60VD	GY40NC60VD	Max247	Tube	

Contents STGY40NC60VD

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STGY40NC60VD Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-emitter voltage (V _{GS} = 0)	600	V	
I _C ⁽¹⁾	Collector current (continuous) at T _C = 25°C 80			
I _C ⁽¹⁾	Collector current (continuous) at T _C = 100°C	50	Α	
I _{CL} ⁽²⁾	Turn-off SOA minimum current	200	Α	
I _F	Diode RMS forward current at T _C = 25°C	30	Α	
V _{GE}	Gate-emitter voltage	±20	V	
P _{TOT}	Total dissipation at T _C = 25°C	260	W	
T _j	Operating junction temperature	-55 to 150	°C	

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{I_{JMAX}^{-1}C}{R_{THJ-C} \times V_{CESAT(MAX)}^{(T_{C}, I_{C})}}$$

2. Pulse width limited by max junction temperature

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit	
Rthj-case	Thermal resistance junction-case max IGBT	0.48	°C/W	
Rthj-case	Thermal resistance junction-case max diode 1.5 °C			
Rthj-amb	Thermal resistance junction-ambient max 50			
T _L	Maximum lead temperature for soldering purpose (1.6mm from case, for 10 sec) typ.	300	°C	

Electrical characteristics STGY40NC60VD

2 Electrical characteristics

 $(T_{CASE}=25^{\circ}C \text{ unless otherwise specified})$

Table 3. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-emitter breakdown voltage	I _C = 1mA, V _{GE} = 0	600			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15V, I _C = 40A V _{GE} = 15V, I _C =40A,Tc=125°C		1.9 1.7	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V_{CE} = Max rating, T_{C} = 25°C V_{CE} = Max rating, T_{C} = 125°C			10 1	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20V, V _{CE} = 0			±100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 15V_{,} I_{C} = 20A$		20		S

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25V, f = 1MHz, V _{GE} = 0		4550 350 105		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390V, I_{C} = 40A, V_{GE} = 15V, Figure 17		214 30 96		nC nC nC

Table 5. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω , V_{GE} = 15V, Figure 18, Figure 16		43 17 2060		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω , V_{GE} = 15V, T_{j} = 125°C Figure 18, Figure 16		42 19 1900		ns ns A/µs
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, Figure 18, Figure 16		25 140 45		ns ns ns
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390V, I_{C} = 40A$ $R_{G} = 3.3\Omega, V_{GE} = 15V,$ $T_{J} = 125^{\circ}C$ Figure 18, Figure 16		60 170 77		ns ns ns

Table 6. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} E _{off} ⁽¹⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, Figure 16		330 720 1050	450 970 1420	μJ μJ μJ
E _{on} E _{off} ⁽¹⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 40A R_{G} = 3.3 Ω V_{GE} = 15V, T_{J} = 125°C Figure 16		640 1400 2040		րJ րJ րJ

^{1.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGY40NC60VD

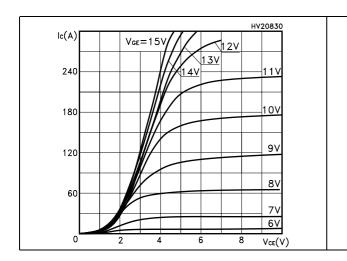
Table 7. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _f	Forward on-voltage	I _f = 20A I _f = 20A, Tj = 125°C		1.5 1	2.2	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_f = 20A,V _R = 40V, Tj = 25°C, di/dt = 100 A/µs Figure 19		44 66 3		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_f = 40A,V _R = 50V, Tj =125°C, di/dt = 100A/µs Figure 19		88 237 5.4		ns nC A

2.1 Electrical characteristics (curves)

Figure 1. Output characteristics

Figure 2. Transfer characteristics



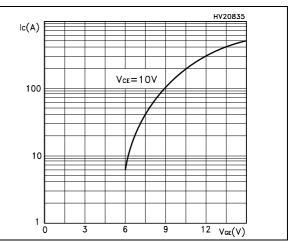
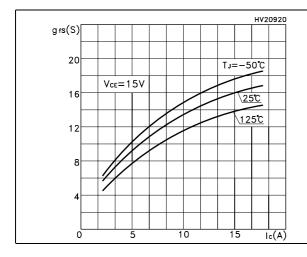


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature



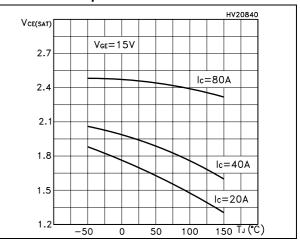
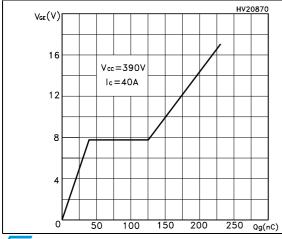
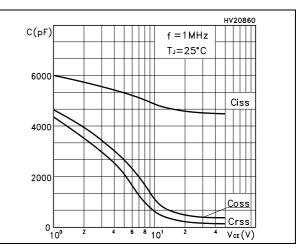


Figure 5. Gate charge vs gate-source voltage Figure 6. Capacitance variations





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Electrical characteristics STGY40NC60VD

Figure 7. Normalized gate threshold voltage Figure 8. Collector-emitter on voltage vs vs temperature collector current

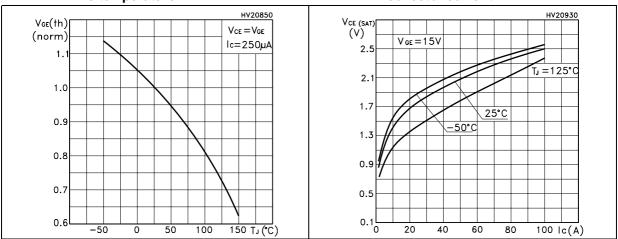


Figure 9. Normalized breakdown voltage vs Figure 10. Switching losses vs temperature temperature

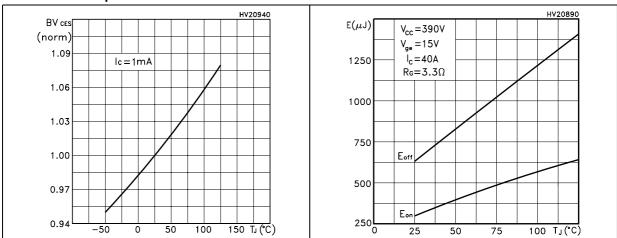
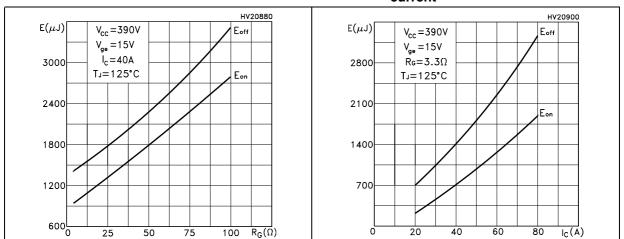


Figure 11. Switching losses vs gate resistance Figure 12. Switching losses vs collector current



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Figure 13. Turn-off SOA

Figure 14. Thermal impedance

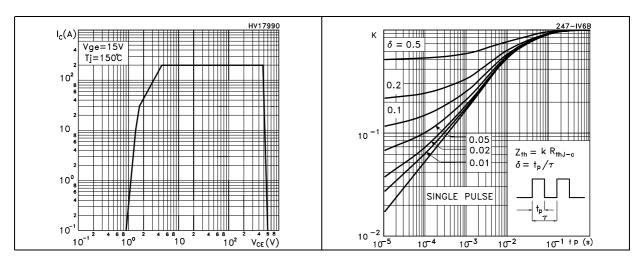
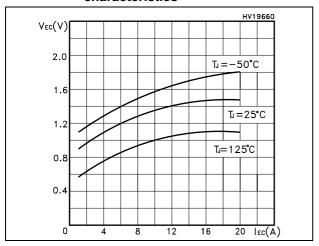


Figure 15. Emitter-collector diode characteristics



Test circuit STGY40NC60VD

3 Test circuit

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

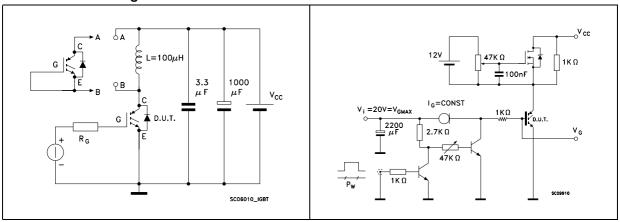
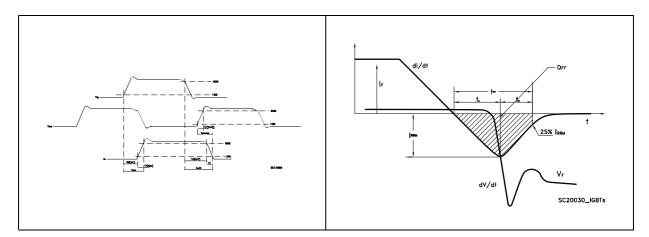


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform



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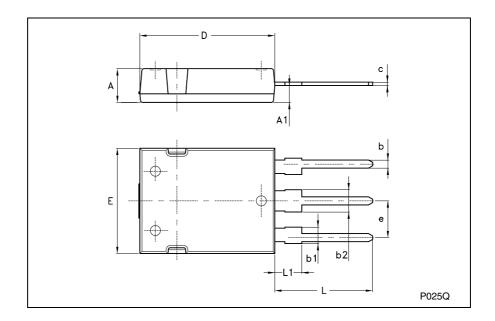
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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Max247 MECHANICAL DATA

DIM.		mm			inch	
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	4.70		5.30			
A1	2.20		2.60			
b	1.00		1.40			
b1	2.00		2.40			
b2	3.00		3.40			
С	0.40		0.80			
D	19.70		20.30			
е	5.35		5.55			
E	15.30		15.90			
L	14.20		15.20			
L1	3.70		4.30			



STGY40NC60VD Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes
07-Jun-2004	7	Initial electronic version.
14-Jul-2004 8		Figure 15 has been update
13-Jul-2007	9	The document has been reformatted, corrected error on Table 4

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